

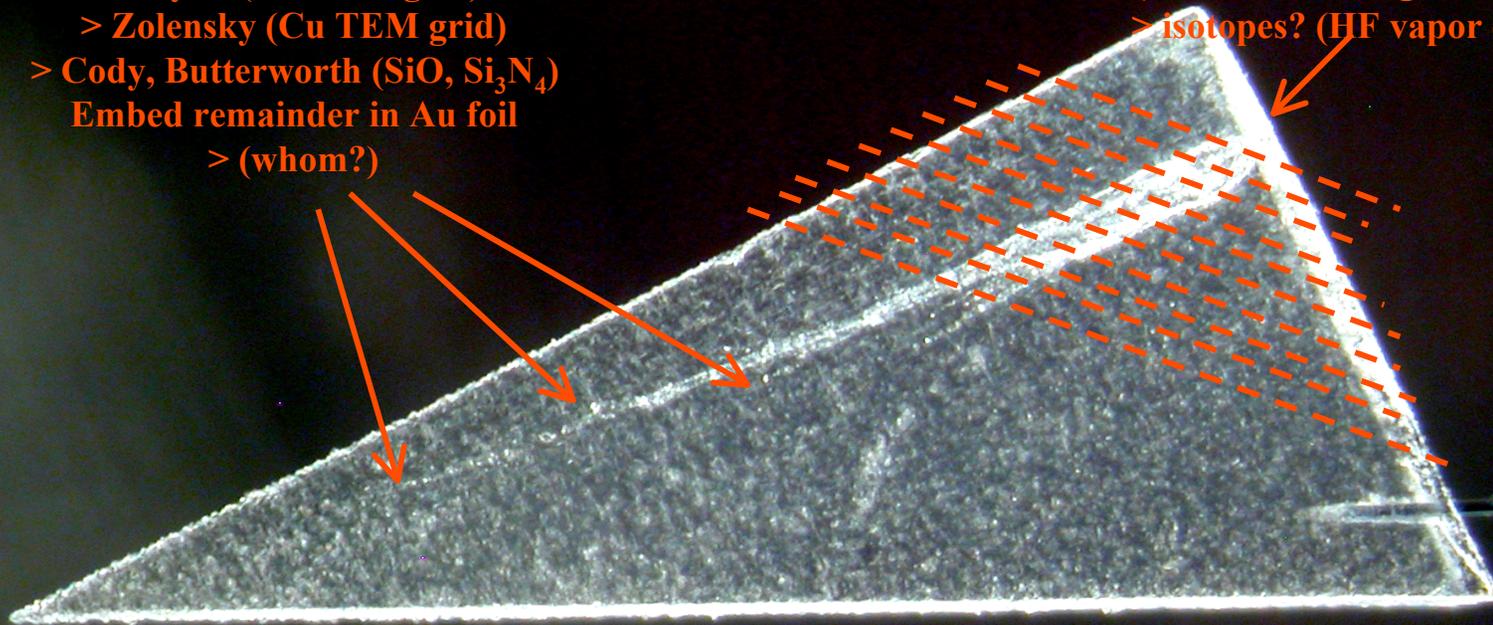
Track c2115,22 (formerly known as C115,0 Track 6) disassembly Plan

1. Extract terminal particle and any other manually extractable particles, ultramicrotome in S

- > Flynn (Au TEM grid)
 - > Zolensky (Cu TEM grid)
 - > Cody, Butterworth (SiO, Si₃N₄)
- Embed remainder in Au foil
> (whom?)

2. Wafer bulb at 45 degree angle

- > Clemett (double-stick tape)
- > Spencer (double-stick tape)
- > Stephan (flattened with mylar onto Si)
- > Grant (clamshell TEM grid, microtweezers)
- > isotopes? (HF vapor etch?)



3. Flatten remainder of keystone, embed in acrylic, slice with razor and ultramicrotome small discrete particles (done by Matrajt *et al.* and/or Westphal *et al.*)

Example of wafered track from ODCE

